SPAR - BRAMPTON (888)

9445 AIRPORT RD

Critical Items List

SRMS

CIL Ref#: 3119

Revision: 0

FMEA Rev: 0

BRAMPTON ONTARIO L884J3

System: SRMS

Subsystem: ELECTRICAL SUB-SYSTEM

Assembly Desc: Servo Power Amplifler

Part Number(s): 51140F1177-3

51140F1177-5

liem:

Function: Filter Board Assembly

Filters 29V to SPA. Filters secondary voltages to position encoder, commutator and tachometer SCU. Provides backup reby to switch motor to backup drive.

Failure Mode: Loss of Deckup relay suppression diode.

H/W Func. Screen Failures

Criticality: 2 1F

Mission Phase: Orbit

Cause(s): Filter Board Assembly

Backup relay-coll supression diode fails open.

Fallure effect on unit/end Hem:

Arcing may occur at D&C Panel backup drive switch when backup is released resulting in premature failure of switch. Backup Drive may be

lost for all joints.

Worst Case: Loss of Backup Drive Mode.

dundant Paths: Computer Supported modes.

Direct Drive,

Retention Rationale

Design:

Discrete asmiconductor devices are specified to at least the TX level of Mit.-S-19500. Samples of all procured tota/date codes are subjected to destructive physical enalysis (DPA) to verify the integrity of the manufacturing processes. Particle impact Noise Detection (PIND) acresing is performed on microcircuits, transistor and diodes that are mounted in a package with an internal cavity construction. The purpose of the test is to detect loose particles in the package, usually resulting from the assembly process. Device stress levels are detailed in accordance with SPAR-RMS-PA.003 and verified by design review.

The SPA board is fabricated using Surface Mount Technology (SMT). This is a PWB assembly technology in which the components are soldered to the solder pada on the surface of the PWB. The significant advantage of this technology is to enable the parts on the board to be more densely packed, to reduce to overall volume and weight of the assembly.

The assembly process is highly automated. The parts are mounted on the boards using a computer controlled "pick and place" machine. The subsequent coldering operation is performed using a belt furnace, in which the time and temperature thermal profile that the PVVB assembly is exposed to is tightly controlled and optimized to ensure proper part soldering attachment. The assembly is manufactured under documented procedures and quality controls. These controls are exercised throughout the assembly, inspection and testing of the unit. This inspection includes workmanship, component mounting, soldering, and conformal coating to ensure that it is in accordance with the NHB 5300 standards.

The SMT line used for the SPA PWB assembly has undergone a full qualification program, and assemblies produced on this line are used in other space programs.

The circuit board design has been reviewed to ensure adequate conductor width and supuration and to confirm appropriate dimensions of solder pads and of component hold provisions. Parts mounting methods are controlled in accordance with MSFC-STD-154A, MSFC-STD-136 and SASD 2573751. These documents require approved mounting methods, stress relief and component security.

Test:

QUALIFICATION TESTS - The SPA is subjected to the following qualification testing:
VIBRATION: Each add of the QM is subjected to Flight Acceptance Vibration Test (FAVT), Qualification Acceptance Vibration Test (QAVT), and Qualification Vibration Tests (QVT) in accordance with the SPA Vibration Test Procedure (626566). The level and guaration for FAVT is as per Figure 6 and Table 2 of 826586; the level and duration for QAVT is as per Figure 8 and Table 2 of 826586. At the end of the three successive random vibration test in each axis, both durations (+/-) of each of the

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axis is subjected to a shock pulse test as per Figure 9 of 326586.

THERMAL/VACUUM: QM TVAC Test is in accordance with Figure 5 of the SPA TVAC Test Procedure (626588), with full Functional/Parametric Test performed at levels of +60 degrees C and -36 degrees C, and non-operating at -54 degrees C. The Qualification vacuum levels during TVAC is 1X10**-6 torr or tess. The total test duration is 7 1/2 cycles. The QM 5PA is subjected to a minimum of 1000. hours of life testing and 1000 power On-Off cycles.

EMC: The QM is subjected to EMC Testing (tests CE01/CE03, CE07, CS01, CS02, C505, RE02, RS02, and RS03) in accordance with the SPA EMC test Procedure (525477) based on MIL-STD-461A.

UNIT FLIGHT ACCEPTANCE TESTS - The FM SPA is subjected to the following acceptance testing: VIBRATION: FM Acceptance Vibration Test (AVT) in accordance with the SPA Vibration Test Procedure (826586), with level and duration as per Figure 6 and Table 2 of 826585.

THERMAL/VACUUM: FM TVAC Test is in accordance with Figure 6 of the SPA TVAC Test Procedure (825555), with levels of +49 degrees C and -25 degrees C for a duration of 1 1/2 cycles. The vacuum levels during Acceptance TVAC Test is 1X10**-5 torr or less.

JOINT SRUITESTS - The SPA is tested as part of the joints (ambient and vibration lests only). The ambient ATP for the Shoulder Joint, Elbow Joint, and Wrist Joint are as per ATP.2001, ATP.2003, and ATP.2005 respectively. The vibration test for the Shoulder Joint, and Elbow or Wrist Joint are as per ATP, 2002, ATP, 2004 and ATP, 2006 respectively. Through wire function, continuity and electifical isolation tests are performed per TP 283,

MECHANICAL ARM REASSEMBLY - The SPA's/Joints undergo a mechanical arm integration stage where electrical checks are performed per TP.2007,

MECHANICAL ARM TESTING - The outgoing split-arm is configured on the Strongback and the Manipulator Arm Checkout is performed per ATP.1932.

FLIGHT CHECKOUT: PDRS OP\$ Checkout (all vehicles) JSC 16967.

Inspection;

Units are manufactured under documented quality controls. These controls are exercised throughout design procurement, planning. receiving, processing, fabrication, assembly, testing and shipping of the units. Mandatory inspection points are employed at various stages of fabrication, assembly, and test. Government source inspection is invoked at various control levels.

EEE parts inspection is performed as required by SPAR-RMS-PA.003. Each EEE part is qualified at the part level to the requirements of applicable specification. All EEE parts are 100% screened and burned-in, as a minimum, as required by SPAR-RMS-PA.003, by the supplier DPA is performed as required by PA,003 on a randomly selected 5% of parts, maximum 5 pleases, minimum 3 pleases for each lot number/date code of parts received. All cavity devices are subjected to 100% PIND. Wire is procured to specification Mit-W-22750 or Mit-W-81381 and inspected and tested to NASA JSCM8080 Standard Number 95A,

Receiving Inspection verifies that all parts received are as identified in the procurement documents, that no physical damage has occurred to parts during shipment, that the receiving documents provide adequate traceability information and screening data clearly identifies acceptable

Parts are inspected throughout manufacture and assembly as appropriate to the manufacturing stage completed. These inspections include: Printed curcuit board inspection for track separation, damage and adequacy of plated through holes, component mounting inspection for correct soldering, wire looping, strapping, etc. Operators and inspectors are trained and certified to NASA NHB 5300.4(3A-1) Standard. Conformal coating inspection for adequate processing is performed using ultraviolet light techniques. P.C. Board installation inspection includes checks for correct board installation, alignment of boards, proper connector contact matting, wire routing, strapping of wires etc. Post P.C. Board installation inspection includes clearliness and workmanship (Sperigovernment rep. mandatory inspection point).

Unit Pre-Acceptance Test inspection, which includes an audit of lower tier inspection completion, as built configuration verification to as design atc (mandatory inspection point). A unit Test Readiness Review (TRR) which includes verification of test personnel, test documents, test equipment calibration/validation status and hardware configuration is convened by QA in conjunction with Engineering, Reliability. Configuration Control, Supplier as applicable, and the government representative, prior to the start of any formal testing (Acceptance or Qualification). Unit level Acceptance Testing (ATP) includes ambient performance, thermal and vibration testing (Spar/government rep. mandatory inspection point).

Integration of unit to Joint SRU - inspections include grounding checks, connectors for bent or pushback contacts, visual, cleanliness. interconnect wiring and power up test to the appropriate Joint Inspection Test Procedure (ITP). Joint level Pre-Acceptance Test Inspection, includes an audit of lower tier inspection completion, as built configuration varification to as design etc. Joint level Acceptance Testing (ATP) includes ambient and vibration bisting (Spar/government rep. mandatory inspection point).

Mechanical Arm Resessambly - the integration of mechanical arm subsessembles to form the assembled arm. Inspections are performed at each phase of integration which includes electrical checks, through wiring checks, wiring routing, interface connectors for bent or pushback contacts etc. Mechanical Arm Testing - Strongback and flat floor ambient performance test (Spar/government rep. mandatory inspection point).

OMRSD Offline: Power-up arm. Verify Backup Drive mode available.

OMRSD Online None.

installation:

OMRSD Online Power-up arm, Verify Backup Orive mode available

Turnaround:

pared: 18Sep96 by Fung, Bill

Supersedus: N/A

SPAR - BRAMPTON (\$SS) 2445 AIRPORT RD

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SRM8

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3RAMPTON ONTARIO L654J3

Screen Failure: A: Page

B: Pass

C: Pass

Craw Training: The crew will be trained to always observe whether the arm is responding property to commands. If it isn't, apply brakes.

Craw Action: Remove the drive command. Select any other mode.

Operational Effect: Loss of next redundant path results in being one failure away from inability to cradic arm. Joint will not drive in Backup, if primary modes have

tailed, the Backup system will not provide the capability to cradle the arm. EVA is available or arm can be justisconed.

Mission If Back-up is lost the mission is considered lost unless there is a flight specific exception.

Constraints:

unctional Group	Name	Position	Telephone	Date Signed	Status
nginser	Hiltz, Michael / SPAR-BRAMPTON	Systems Engineer	4634	06Mar98	Signes
elmibility	Molgaard, Lene / SPAR-BRAMPTON	Reliability Engineer	4590	06Mar98	Signed
ogram Management Offic	Rice, Craig / SPAR-BRAMPTON	Technical Program Manager	4892	06Mar98	Signed
bayatem Manager	Glenn, George / JSC-ER	RMS Subsystem Manager	(281) 483-1516	30Mar98	Signed
chnical Manager	Allison, Ron / JSC-MV6	RM8 Project Engineer JSC	(713) 483-4072	09Apr98	Signed

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